

DUAL 1 TO 8 BUFFALO™ CLOCK DRIVER

MK74CB218B

Description

The MK74CB218B Buffalo™ is a monolithic CMOS high speed clock driver. It consists of two identical single input to eight low-skew output, non-inverting clock drivers. This eliminates concerns of part to part matching in many systems. The MK74CB218B is packaged in the tiny 28-pin SSOP, which uses the same board space as the narrow 16-pin SOIC. The inputs can be connected together for a 1 to 16 fanout buffer.

A quad 1 to 4, and PECL versions, are also available. Consult IDT for more details.

The MK74CB218B can also act as a voltage translator, since it is possible to run the inputs at 3.3 V and the outputs at 2.5 V.

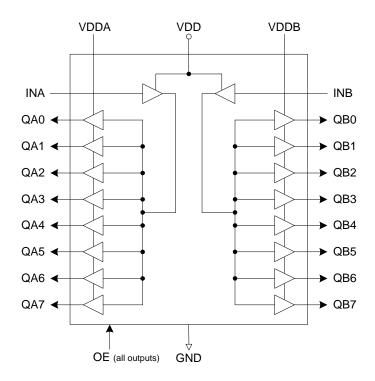
Features

- Packaged as 28-pin SSOP (150 mil body)
- Pb (lead) free package, RoHS compliant
- Dual one input to eight output clock drivers
- Outputs are skew matched to within 250 ps
- A outputs and B outputs matched to 250 ps
- 2.5 V or 3.3 V output voltages
- · Output Enable tri-states each bank of eight
- Clock speeds up to 200 MHz

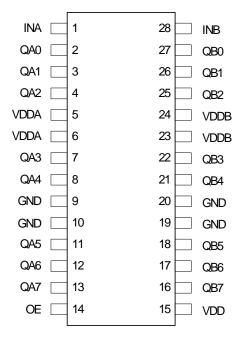
Family of IDT Parts

The MK74CB218B Buffalo™ is designed to be used with IDT's clock synthesizer devices. The inputs of the Buffalo are matched to the outputs of IDT clock synthesizers. Consult IDT for applications support.

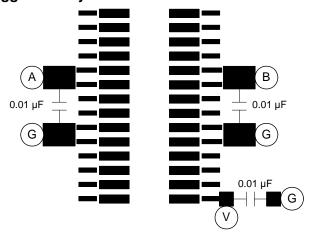
Block Diagram



Pin Assignment



Suggested Layout



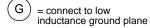
NOTE: 33 ohm series termination resistors for each output are essential for operation.

For simplicity, series termination resistors are not shown for the outputs, but should be placed as close to the device as possible. It is most critical to have the 0.01 μF decoupling capacitors closest.









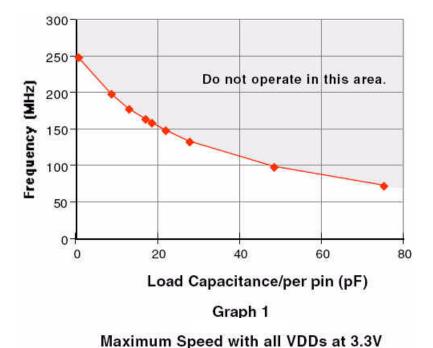
Pin Descriptions

Pin Number	Pin Name	Pin Type	Pin Description
1	INA	Input	Clock input for eight A outputs.
2, 3, 4	QA0, QA1, QA2	Output	Clock A outputs.
5, 6	VDDA	Power	Power supply for QA outputs. Connect to a voltage from 2.5 V to VDD. Cannot exceed VDD.
7, 8	QA3, QA4	Output	Clock A outputs.
9, 10	GND	Power	Connect to ground.
11, 12, 13	QA5, QA6, QA7	Output	Clock A outputs.
14	OE	Input	Output Enable. Tri-states all clock outputs when this input is low. Internal pull-up to VDD.
15	VDD	Power	Power supply for inputs.
16, 17, 18	QB7, QB6, QB5	Output	Clock B outputs.
19, 20	GND	Power	Connect to ground.
21, 22	QB4, QB3	Output	Clock B outputs.
23, 24	VDDB	Power	Power supply for QB outputs. Connect to a voltage from 2.5 V to VDD. Cannot exceed VDD.
25, 26, 27	QB2, QB1, QB0	Output	Clock B outputs.
28	INB	Input	Clock input for eight B outputs.

Maximum Speed

The maximum speed at which the chip can operate is limited by the power dissipation in the package. Graph 1 shows the operating frequency plotted against load capacitance per pin for a die temperature of 125° C. This is at VDD = VDDA = VDDB = 3.3 V, 70° C and with 33Ω series termination resistors. The termination resistors are essential because they allow a large proportion of the total power dissipated outside the package. Reducing or eliminating the series termination will cause an increase in die temperature. It is not recommended to operate the chip at die temperatures greater than 125° C. Also note that the load capacitance per pin must include PC board parasitics such as trace capacitance.

If not all outputs of the chip are used, it is possible to operate the chip faster with larger loads. Consult IDT for your specific requirement.



Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the MK74CB218B. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating		
Supply Voltage, VDD (referenced to GND)	5.2 V		
All Inputs and Outputs (referenced to GND)	-0.5 V to VDD+0.5 V		
Ambient Operating Temperature	0 to +70°C		
Storage Temperature	-65°C to 150°C		
Soldering Temperature	260°C (max. of 20 seconds)		

DC Electrical Characteristics

Unless stated otherwise, VDD = 3.3 V ±10%

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Operating Voltage	VDD		3.0	3.3	3.6	V
Operating Voltage	VDDA or VDDB		2.375		VDD	V
Operating Supply Current	IDD	At 100 MHz, No load		55		mA
Input High Voltage	V _{IH}	INA, INB pins	0.65VDD			V
Input Low Voltage	V _{IL}	INA, INB pins			0.35VDD	V
Input High Voltage	V _{IH}	OE pin	2.0			V
Input Low Voltage	V _{IL}	OE pin			0.8	V
Output High Voltage	V _{OH}	I _{OH} = -12 mA	VDD-0.4			V
Output High Voltage	V _{OH}	I _{OH} = -25 mA	2.4			V
Output Low Voltage	V _{OL}	I _{OL} = 25 mA			0.8	V
Output High Voltage	V _{OH}	VDD = 2.5 V, I _{OH} = -16 mA	2			V
Output Low Voltage	V _{OL}	VDD = 2.5 V, I _{OL} = 16 mA			0.5	V
Output Impedance				14		Ω
Short Circuit Current		Each output, VOUT=GND or VDD		100		mA
Input Capacitance	C _{IN}			7		pF
On-chip Pull-up Resistor	R _{PU}	OE		250		kΩ

Note: Short circuits may be applied indefintely, but only one output may be shorted at a time to prevent exceeding the power dissipation rating of this package.

AC Electrical Characteristics

Unless stated otherwise, VDD = 3.3 V ±10%

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Input Clock Frequency	F _{IN}	Note 3	0		200	MHz
Propagation Delay, 3.3 V		With load = 15 pF		3	6	ns
Propagation Delay, 4.8 V						
Output Clock Rise Time		20% to 80%, C _L =10 pF		1	2	ns
Output Clock Rise Time		VDD = 2.5 V, 20% to 80%, C _L =10 pF		1	2	ns
Output Clock Fall Time		80% to 20%, C _L =10 pF		1	2	ns
Output Clock Fall Time		VDD = 2.5 V, 80% to 20%, C _L =10 pF		1	2	ns
Output Duty Cycle		VDD = 3.3 V or 2.5 V, C _L =10 pF	40	50	60	%
Output Clock Rising Edge Skew		At VDD/2, Note 1		100	250	ps
Output Clock A to B Skew		At VDD/2, Note 2		100	250	ps
Output Enable Time		OE high to output on			20	ns
Output Disable Time		OE low to tri-state			20	ns

Notes:

- 1. Between any two A outputs, or any two B outputs, with equal loading.
- 2. Between any clock A output and any clock B output with INA connected to INB, and equal loading.
- 3. See discussion and graph of speed versus load.

Thermal Characteristics

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Thermal Resistance Junction to	$\theta_{\sf JA}$	Still air		100		°C/W
Ambient	$\theta_{\sf JA}$	1 m/s air flow		80		°C/W
	$\theta_{\sf JA}$	3 m/s air flow		67		°C/W
Thermal Resistance Junction to Case	$\theta_{\sf JC}$			60		°C/W

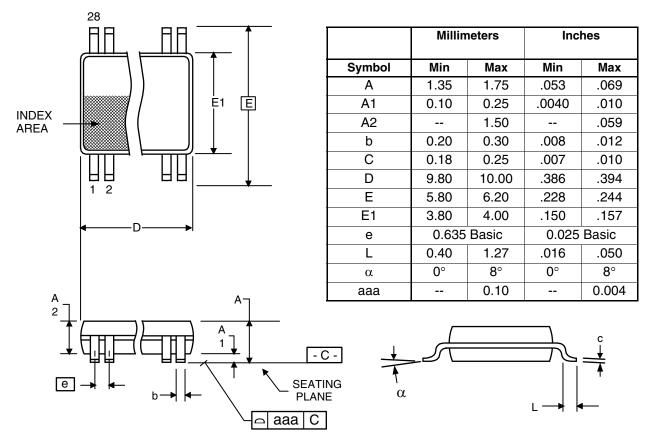
Marking Diagram



- 1. "LOT" designates the lot number.
- 2. "YYWW" designated the date code.
- 3. "LF" suffix to the part number designates Pb-free.
- 4. "•" designates pin 1.

Package Outline and Package Dimensions (28-pin SSOP, 150 mil Body)

Package dimensions are kept current with JEDEC Publication No. 95, MO-153



Ordering Information

Part / Order Number	Marking	Shipping Packaging	Package	Temperature
MK74CB218BRLF	MK74CB218BRLF	Tubes	28-pin SSOP	0 to +70°C
MK74CB218BRLFTR	MK74CB218BRLF	Tape and Reel	28-pin SSOP	0 to +70°C

"LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

While the information presented herein has been checked for both accuracy and reliability, Integrated Device Technology (IDT) assumes no responsibility for either its use or for the infringement of any patents or other rights of third parties, which would result from its use. No other circuits, patents, or licenses are implied. This product is intended for use in normal commercial applications. Any other applications such as those requiring extended temperature range, high reliability, or other extraordinary environmental requirements are not recommended without additional processing by IDT. IDT reserves the right to change any circuitry or specifications without notice. IDT does not authorize or warrant any IDT product for use in life support devices or critical medical instruments.

Revision History

Rev.	Date	Originator	Description of Change
D	01/18/13	S. Lou	Updated marking information to add "F" at the end of the part number.

FAN OUT BUFFER

IMPORTANT NOTICE AND DISCLAIMER

RENESAS ELECTRONICS CORPORATION AND ITS SUBSIDIARIES ("RENESAS") PROVIDES TECHNICAL SPECIFICATIONS AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, WITHOUT LIMITATION, ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for developers skilled in the art designing with Renesas products. You are solely responsible for (1) selecting the appropriate products for your application, (2) designing, validating, and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. Renesas grants you permission to use these resources only for development of an application that uses Renesas products. Other reproduction or use of these resources is strictly prohibited. No license is granted to any other Renesas intellectual property or to any third party intellectual property. Renesas disclaims responsibility for, and you will fully indemnify Renesas and its representatives against, any claims, damages, costs, losses, or liabilities arising out of your use of these resources. Renesas' products are provided only subject to Renesas' Terms and Conditions of Sale or other applicable terms agreed to in writing. No use of any Renesas resources expands or otherwise alters any applicable warranties or warranty disclaimers for these products.

(Rev.1.0 Mar 2020)

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

Contact Information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit:

www.renesas.com/contact/

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Clock Drivers & Distribution category:

Click to view products by Renesas manufacturer:

Other Similar products are found below:

8501BYLF P9090-0NLGI8 854110AKILF 83210AYLF NB6VQ572MMNG HMC6832ALP5LETR RS232-S5 6ES7390-1AF30-0AA0
CDCVF2505IDRQ1 LV5609LP-E NB7L572MNR4G SY100EP33VKG ISPPAC-CLK5520V-01T100C EC4P-221-MRXD1 6EP1332-1SH71
6ES7222-1BH32-0XB0 6ES7231-4HD32-0XB0 AD246JN AD246JY AD9510BCPZ AD9510BCPZ-REEL7 AD9511BCPZ AD9511BCPZ-REEL7 AD9512BCPZ AD9512UCPZ-EP AD9513BCPZ AD9514BCPZ AD9514BCPZ-REEL7 AD9515BCPZ AD9515BCPZ AD9515BCPZ-REEL7
AD9572ACPZLVD AD9572ACPZPEC AD9513BCPZ-REEL7 ADCLK950BCPZ-REEL7 ADCLK950BCPZ AD9553BCPZ HMC940LC4B
HMC6832ALP5LE CSPUA877ABVG8 9P936AFLFT 49FCT3805ASOG 49FCT3805DQGI 49FCT3805EQGI 49FCT805CTQG
74FCT3807EQGI 74FCT388915TEPYG 853S013AMILF 853S058AGILF 8SLVD1208-33NBGI 8V79S680NLGI